- **Member of the Texas Instruments Widebus™ Family**
- **Supports SSTL_3 Signal Inputs and Outputs**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Meets SSTL_3 Class I and Class II Specifications**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **Packaged in Plastic Thin Shrink Small-Outline Package**

description

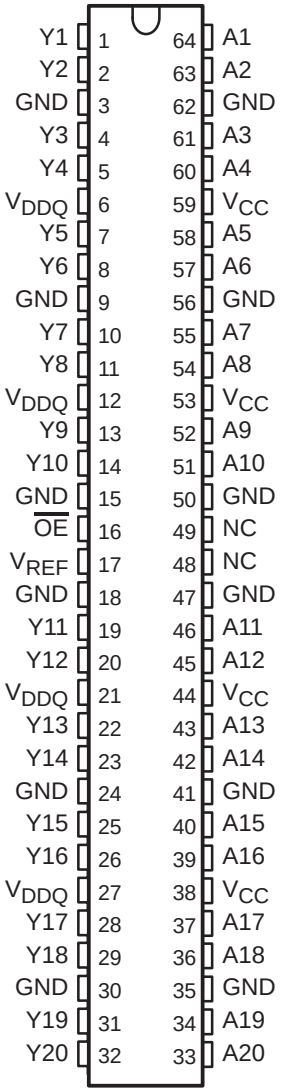
This 20-bit buffer is designed for 3-V to 3.6-V V_{CC} operation and SSTL_3 input levels.

Data flow from A to Y is controlled by the output-enable ($\overline{OE}$). When $\overline{OE}$ is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74SSTL16847 is characterized for operation from 0°C to 70°C.

DGG PACKAGE
(TOP VIEW)

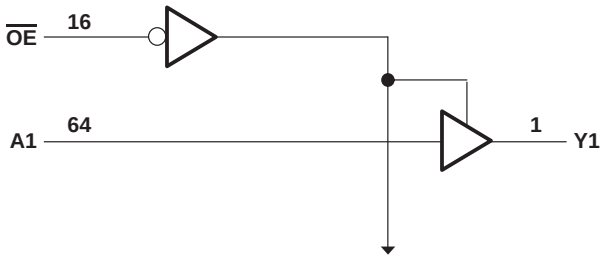


NC – No internal connection

FUNCTION TABLE

INPUTS		OUTPUT
$\overline{OE}$	A	Y
L	H	H
L	L	L
H	X	Z

logic diagram (positive logic)



To 19 Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} or V_{DDQ} . . . . . –0.5 V to 4.6 V
Input voltage range, V_I (see Note 1) . . . . . –0.5 V to V_{CC} + 0.5 V
Output voltage range, V_O (see Notes 1 and 2) . . . . . –0.5 V to V_{DDQ} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) . . . . . –50 mA
Output clamp current, I_{OK} (V_O < 0) . . . . . –50 mA
Continuous output current, I_O (V_O = 0 to V_{DDQ}) . . . . . ±50 mA
Continuous current through each V_{CC}, V_{DDQ} or GND . . . . . ±100 mA
Package thermal impedance, θ_{JA} (see Note 3): . . . . . 73°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This current will flow only when the output is in the high state and $V_O > V_{DDQ}$.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		V_{DDQ}		3.6	V
V_{DDQ}	Output supply voltage		3		3.6	V
V_{REF}	Reference voltage ($V_{REF} = 0.45 \times V_{DDQ}$)		1.3	1.5	1.7	V
V_{TT}	Termination voltage		V_{REF}–50mV	V_{REF}	V_{REF}+50mV	V
V_I	Input voltage		0		V_{CC}	V
V_{IH}	AC high-level input voltage	All inputs	V_{REF}+400mV			V
V_{IL}	AC low-level input voltage	All inputs			V_{REF}–400mV	V
V_{IH}	DC high-level input voltage	All inputs	V_{REF}+200mV			V
V_{IL}	DC low-level input voltage	All inputs			V_{REF}–200mV	V
I_{OH}	High-level output current				–20	mA
I_{OL}	Low-level output current				20	mA
T_A	Operating free-air temperature		0		70	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V_{CC}	MIN	TYP†	MAX	UNIT
V_{IK}		I_I = –18 mA		3 V			–1.2	V
V_{OH}		I_{OH} = –100 μA		3 V to 3.6 V	V_{CC}–0.2			V
		I_{OH} = –16 mA		3 V	2.2			
		I_{OH} = –20 mA			2.1			
V_{OL}		I_{OL} = 100 μA		3 V to 3.6 V			0.2	V
		I_{OL} = 16 mA		3 V			0.5	
		I_{OL} = 20 mA					0.55	
I_I	Data inputs, $\overline{OE}$	V_I = 2.1 V or 0.9 V,	V_{REF} = 1.3 V or 1.7 V	3.6 V			±5	μA
	V_{REF}	V_{REF} = 1.3 V or 1.7 V					±150	μA
I_{OZ}		V_O = 0.9 V or 2.1 V		3.6 V			±10	μA
I_{CC}		V_I = 2.1 V or 0.9 V,	I_O = 0	3.6 V			90	mA
C_i	Control inputs	V_I = 2.1 V or 0.9 V		3.3 V		2		pF
	A port					2.5		
C_o	Y port	V_O = 2.1 V or 0.9 V		3.3 V		3.5		pF

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

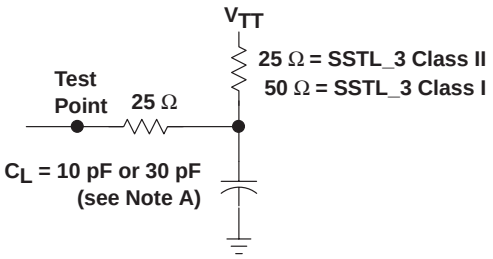
switching characteristics over recommended operating free-air temperature range, Class I, $V_{REF} = V_{TT} = V_{DDQ}$ X 0.45 and C_L = 10 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t_{pd}	A	Y	1.5	3	ns
t_{en}	$\overline{OE}$	Y	1.5	4	ns
t_{dis}	$\overline{OE}$	Y	1.6	4.9	ns

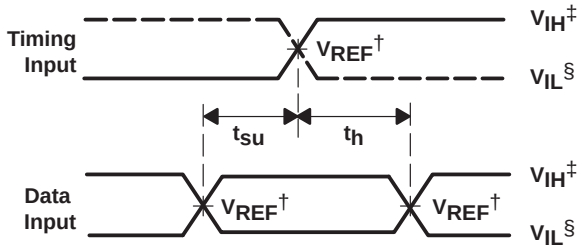
switching characteristics over recommended operating free-air temperature range, Class II, $V_{REF} = V_{TT} = V_{DDQ}$ X 0.45 and C_L = 30 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t_{pd}	A	Y	1.5	3	ns
t_{en}	$\overline{OE}$	Y	1.5	4.1	ns
t_{dis}	$\overline{OE}$	Y	1.5	4.8	ns

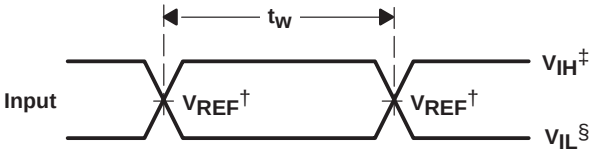
PARAMETER MEASUREMENT INFORMATION



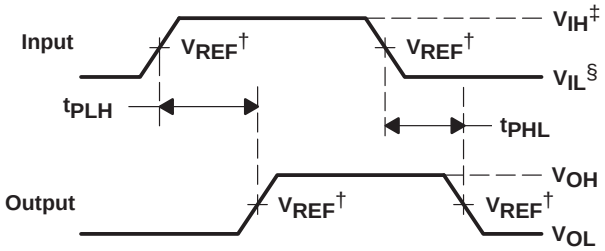
LOAD CIRCUIT



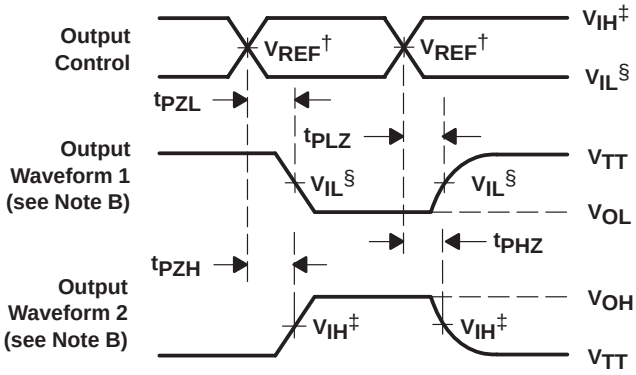
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

† $V_{REF} = 0.45\ V_{DDQ}$
‡ $V_{IH} = V_{REF}+400mV$ (AC voltage levels)
§ $V_{IL} = V_{REF}–400mV$ (AC voltage levels)

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, $Z_O = 50\ \Omega$, $t_r \le 1.25$ ns/V, $t_f \le 1.25$ ns/V.
D. The outputs are measured one at a time with one transition per measurement.
E. $V_{TT} = V_{REF} = V_{DDQ} \times 0.45$
F. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
G. t_{PZL} and t_{PZH} are the same as t_{en}.
H. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

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